

## RU55L18R-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY		
V <sub>DS</sub>	-60	V
R <sub>DS(on)</sub> V <sub>GS</sub> = 10 V	62	mΩ
$R_{DS(on)}$ $V_{GS} = 4.5$ V	74	mΩ
I <sub>D</sub>	-40	А
Configuration	Sin	gle

## **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % UIS Tested

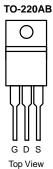
#### **APPLICATIONS**

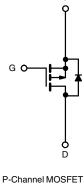
Load Switch

S



Unit





<b>ABSOLUTE MAXIMUM RATINGS</b> $T_C = 25$ °C, unless othe	rwise noted	
Parameter	Symbol	Limit
Gate-Source Voltage	V <sub>GS</sub>	± 20

Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current (T <sub>1</sub> = 175 °C)	T <sub>C</sub> = 25 °C	1-	-40		
	T <sub>C</sub> = 100 °C	- I <sub>D</sub>	-30		
Pulsed Drain Current		I <sub>DM</sub>	- 90	A	
Continuing Source Current (Diode Conduction)		۱ <sub>S</sub>	- 30		
Avalanche Current		I <sub>AS</sub>	- 28		
Single Pulse Avalanche Energy L = 0.1 mH		E <sub>AS</sub>	7.2	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	60 <sup>a</sup>	W	
Maximum Fower Dissipation	T <sub>A</sub> = 25 °C	ГD	2 <sup>b</sup>	~~~	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
lun sting to Ambient	t ≤ 10 sec	R <sub>thJA</sub>	20	25	
Junction-to-Ambient <sup>b</sup>	Steady State	' 'thJA	62	75	°C/W
Junction-to-Case		R <sub>thJC</sub>	5	6	

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on 1" x 1" FR-4 boad.

<b>SPECIFICATIONS</b> $T_J = 25$	°C, unless	otherwise noted				
Parameter	Symbol	Test Conditions	Min	Typ <sup>a</sup>	Max	Unit
Static	•	· · · ·				
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	- 1.0		- 3.0	v
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
		$V_{DS} = -60 V, V_{GS} = 0 V$			- 1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ = - 60 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C			- 50	μA
		$V_{DS}$ = - 60 V, $V_{GS}$ = 0 V, $T_{J}$ = 175 °C			- 150	
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = - 5 V, V <sub>GS</sub> = - 10 V	- 10			А
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5 A		62		
	r	$V_{GS}$ = - 10 V, $I_D$ = - 5 A, $T_J$ = 125 °C		80	mΩ	
Drain-Source On-State Resistance <sup>b</sup>	r <sub>DS(on)</sub>	$V_{GS}$ = - 10 V, $I_D$ = - 5 A, $T_J$ = 175 °C		110 mΩ 74		
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 2 A		74		- S
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 5 A		8		S
Dynamic	•	•		÷	•	
Input Capacitance	C <sub>iss</sub>			1300		
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = - 25 V, $V_{GS}$ = 0 V, f = 1 MHz		120		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			90		
Total Gate Charge	Qg			13		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -8.4 \text{ A}$		2.3		s
Gate-Drain Charge	Q <sub>gd</sub>			3.2		
Gate Resistance	Rg	f = 1 MHz		8.0		Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			5	10	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = - 30 V, $R_L$ = 3.57 $\Omega$		14	25	20
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong$ - 8.4 A, $V_{GEN}$ = - 10 V, $R_G$ = 2.5 $\Omega$		15	25	115
Fall Time <sup>c</sup>	t <sub>f</sub>	]		7	12	
Source-Drain Diode Ratings and Cha	aracteristics	(T <sub>C</sub> = 25 °C) <sup>b</sup>			•	
Pulsed Current	I <sub>SM</sub>			- 20		А
Forward Voltage <sup>b</sup>	V <sub>SD</sub>	I <sub>F</sub> = - 2 A, V <sub>GS</sub> = 0 V		- 0.9	- 1.3	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 8 A, di/dt = 100 A/μs		50	80	ns
Reverse Recovery Time	Q <sub>rr</sub>	$r_{\rm F} = -0.7$ , $u/u_{\rm F} = -00.7$ , $\mu_{\rm S}$		80	120	nC

Notes:

a. Guaranteed by design, not subject to production testing.

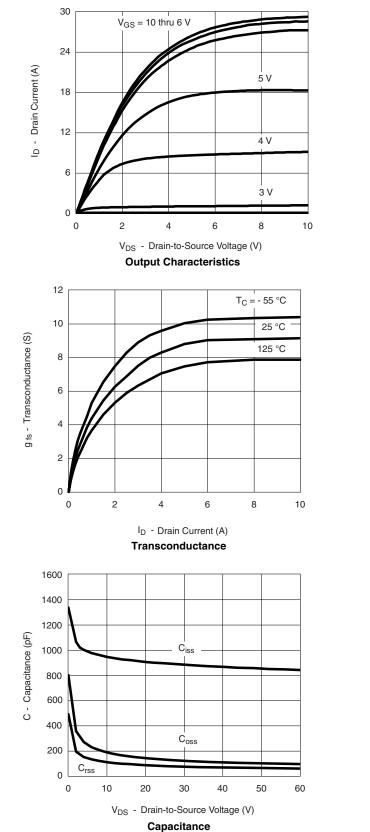
b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

c. Independent of operating temperature.

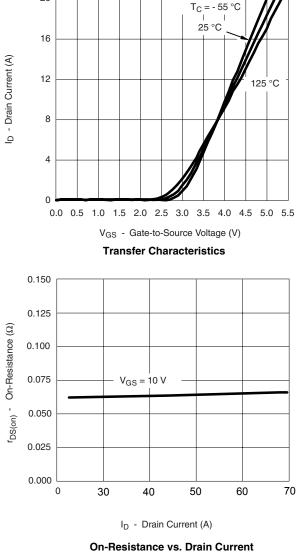
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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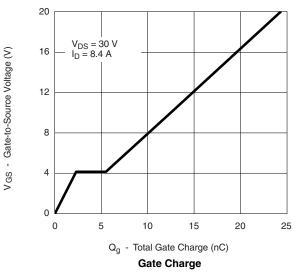




### TYPICAL CHARACTERISTICS 25 °C unless noted

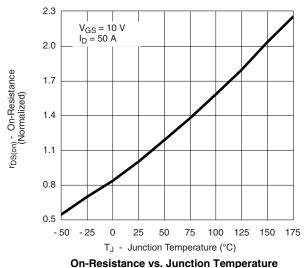


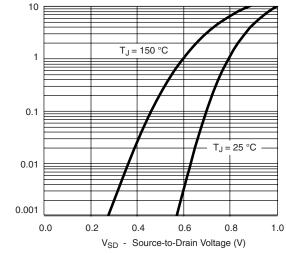
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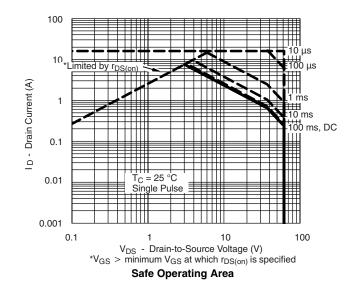
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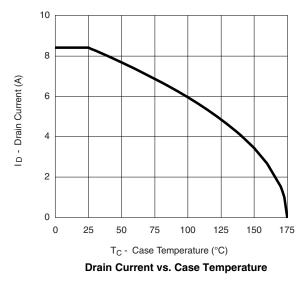


IS - Source Current (A)

Source-Drain Diode Forward Voltage

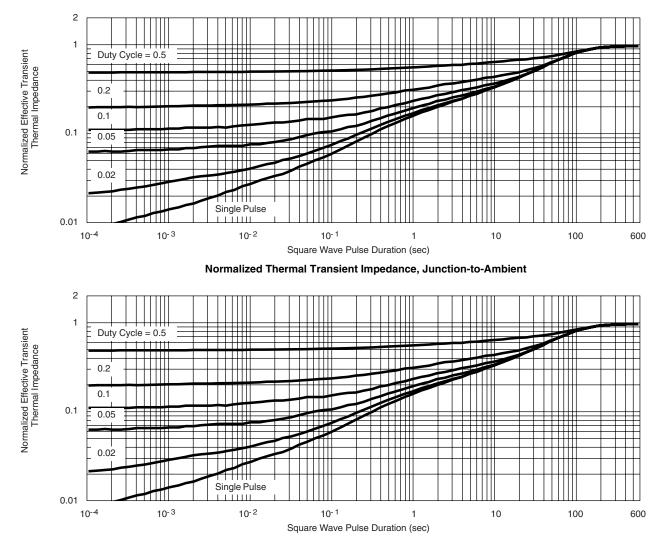


#### **THERMAL RATINGS**



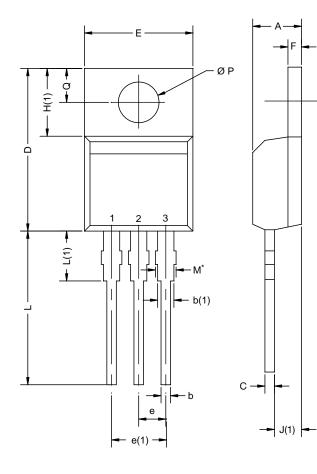


#### THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case





## **TO-220AB**

	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

#### Notes

 $^{\star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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